

L Number	Hits	Search Text	DB	Time stamp
-	2482	257/787	USPAT	2004/04/27 11:36
-	1964	257/787 and (mold\$3 or encapsulat\$3 or cover near resin)	USPAT	2004/04/27 11:54
-	847	257/787 and (mold\$3 or encapsulat\$3 or cover near resin)	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/27 12:23
-	166	257/788 and (mold\$3 or encapsulat\$3 or cover near resin)	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/27 12:39
-	548	257/788 and (mold\$3 or encapsulat\$3 or cover near resin)	USPAT	2004/04/27 12:40